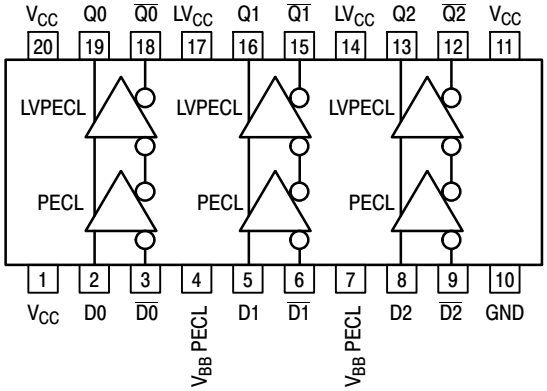


Warning: All V_{CC}, LV_{CC}, and GND pins must be externally connected to Power Supply to guarantee proper operation.

Figure 1. Logic Diagram and Pinout: SO−20 WB (Top View)

Table 1. PIN DESCRIPTION

PIN	FUNCTION
Dn, $\overline{Dn}$	PECL Inputs
Qn, $\overline{Qn}$	LVPECL Outputs
PECL V_{BB}	PECL Reference Voltage Output
LV_{CC}	LVPECL Power Supply
V_{CC}	PECL Power Supply
GND	Common Ground Rail

Table 2. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V_{CC}	PECL Power Supply	GND = 0 V		8 to 0	V
LV_{CC}	LVPECL Power Supply	GND = 0 V		8 to 0	V
V_I	PECL Input Voltage	GND = 0 V	$V_I \leq V_{CC}$	6 to 0	V
I_{out}	Output Current	Continuous Surge		50 100	mA mA
I_{BB}	PECL V_{BB} Sink/Source			± 0.5	mA
T_A	Operating Temperature Range			−40 to +85	°C
T_{stg}	Storage Temperature Range			−65 to +150	°C
θ_{JA}	Thermal Resistance (Junction−to−Ambient)	0 lfpm 500 lfpm	SOIC−20 WB SOIC−20 WB	90 60	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction−to−Case)	Standard Board	SOIC−20 WB	30 to 35	°C/W
T_{sol}	Wave Solder Pb Pb−Free	<2 to 3 sec @ 248°C <2 to 3 sec @ 260°C		265 265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. PECL INPUT DC CHARACTERISTICS V_{CC} = 5.0 V; LV_{CC} = 3.3 V; GND = 0 V Note 1)

Symbol	Characteristic	−40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
IV_{CC}	PECL Power Supply Current			12			12			12	mA
V_{IH}	Input HIGH Voltage (Single−Ended)	3835		4120	3835		4120	3835		4120	mV
V_{IL}	Input LOW Voltage (Single−Ended)	3190		3515	3190		3525	3190		3525	mV
PECL V_{BB}	Output Voltage Reference	3.62		3.74	3.62		3.74	3.62		3.74	V
V_{IHCMR}	Input HIGH Voltage Common Mode Range (DIfferential) (Note 2) V_{pp} < 500 mV $V_{pp} \geqq$ 500 mV	 1.3 1.5		 4.8 4.8	 1.2 1.4		 4.8 4.8	 1.2 1.4		 4.8 4.8	 V V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current D $\overline{D}$	0.5 −600			0.5 −600			0.5 −600			μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Input parameters vary 1:1 with V_{CC}. V_{CC} can vary 4.5 V to 5.5 V.
2. V_{IHCMR} min varies 1:1 with GND. V_{IHCMR} max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PP}min and 1.0 V.

Table 4. LVPECL OUTPUT DC CHARACTERISTICS V_{CC} = 5.0 V; LV_{CC} = 3.3 V; GND = 0 V (Note 3)

Symbol	Characteristic	−40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
ILV_{CC}	LVPECL Power Supply Current			20			20			21	mA
V_{OH}	Output HIGH Voltage (Note 4)	2215	2295	2420	2275	2345	2420	2275	2345	2420	mV
V_{OL}	Output LOW Voltage (Note 4)	1470	1605	1745	1490	1595	1680	1490	1595	1680	mV

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

3. Output parameters vary 1:1 with LV_{CC}. V_{CC} can vary 3.0 V to 3.8 V.
4. Outputs are terminated through a 50 Ω resistor to LV_{CC} − 2.0 V.

Table 5. AC CHARACTERISTICS V_{CC} = 5.0 V; LV_{CC} = 3.3 V; GND = 0 V (Note 5)

Symbol	Characteristic	−40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
f_{max}	Maximum Toggle Frequency		TBD			TBD			TBD		GHz
t_{PLH} t_{PHL}	Propagation Delay Diff D to Q S.E.	490 440	590 590	690 740	510 460	610 610	710 760	530 480	630 630	730 780	ps
t_{SKEW}	Skew Output−to−Output (Note 6) Part−to−Part (Diff) (Note 6) Duty Cycle (Diff) (Note 7)		20 20 25	100 200		20 20 25	100 200		20 20 25	100 200	ps
t_{JITTER}	Cycle−to−Cycle Jitter		TBD			TBD			TBD		ps
V_{PP}	Input Swing (Note 8)	150		1000	150		1000	150		1000	mV
t_r t_f	Output Rise/Fall Times Q (20% − 80%)	270		530	270		530	270		530	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

5. LV_{CC} can vary 3.0 V to 3.8 V; V_{CC} can vary 4.5 V to 5.5 V. Outputs are terminated through a 50 Ω resistor to LV_{CC} − 2.0 V.
6. Skews are valid across specified voltage range, part−to−part skew is for a given temperature.
7. Duty cycle skew is the difference between a t_{PLH} and t_{PHL} propagation delay through a device.
8. V_{PP}(min) is the minimum input swing for which AC parameters are guaranteed. The device has a DC gain of ≈40.

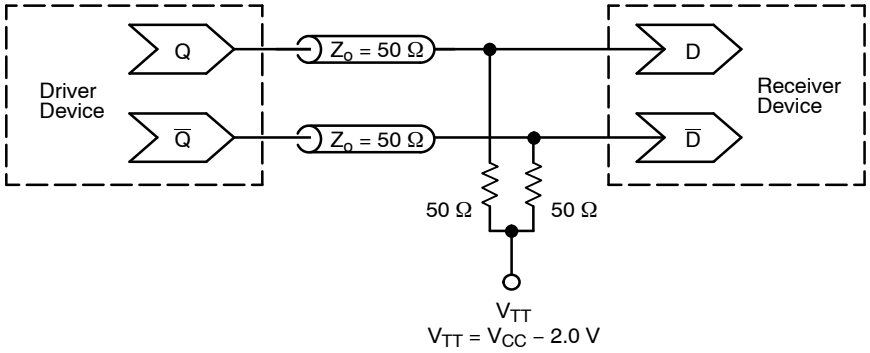


Figure 2. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D − Termination of ECL Logic Devices.)

ORDERING INFORMATION

Device	Package	Shipping†
MC100LVEL92DW	SO−20 WB	38 Units / Rail
MC100LVEL92DWG	SO−20 WB (Pb−Free)	38 Units / Rail
MC100LVEL92DWR2	SO−20 WB	1000 / Tape & Reel
MC100LVEL92DWR2G	SO−20 WB (Pb−Free)	1000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Resource Reference of Application Notes

AN1405/D – ECL Clock Distribution Techniques

AN1406/D – Designing with PECL (ECL at +5.0 V)

AN1503/D – ECLinPS™ I/O SPiCE Modeling Kit

AN1504/D – Metastability and the ECLinPS Family

AN1568/D – Interfacing Between LVDS and ECL

AN1672/D – The ECL Translator Guide

AND8001/D – Odd Number Counters Design

AND8002/D – Marking and Date Codes

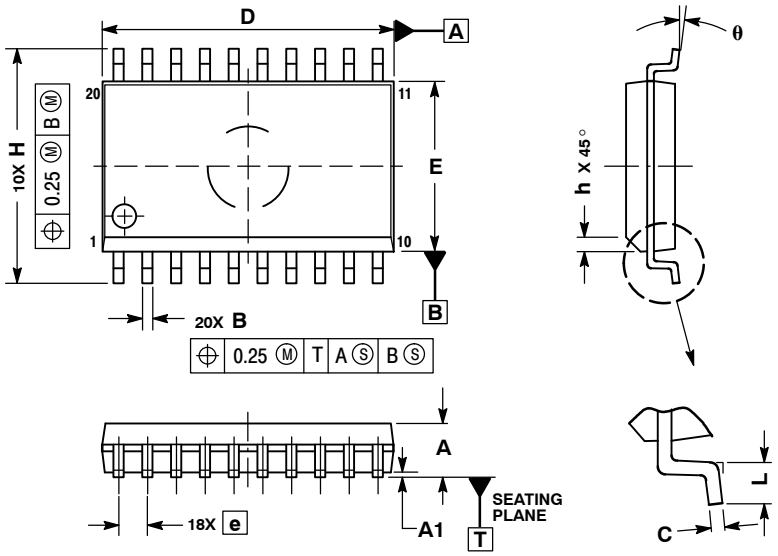
AND8020/D – Termination of ECL Logic Devices

AND8066/D – Interfacing with ECLinPS

AND8090/D – AC Characteristics of ECL Devices

PACKAGE DIMENSIONS

SO−20 WB
DW SUFFIX
CASE 751D−05
ISSUE G



NOTES:
1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS	
DIM	MIN	MAX
A	2.35	2.65
A1	0.10	0.25
B	0.35	0.49
C	0.23	0.32
D	12.65	12.95
E	7.40	7.60
e	1.27 BSC	
H	10.05	10.55
h	0.25	0.75
L	0.50	0.90
θ	0°	7°

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